



30V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
30V	6mΩ @ V _{GS} = 10V	60A
30 V	9mΩ @ V _{GS} = 4.5V	48A

Description

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Power Management Functions
- Analog Switch

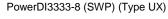
Features

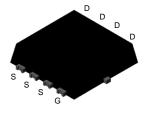
- Low Rds(ON) Ensures On-State Losses are Minimized
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

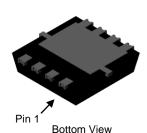
Mechanical Data

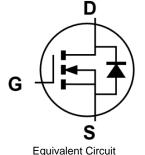
- Case: PowerDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.03 grams (Approximate)











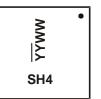
Ordering Information (Note 4)

Part Number	Case	Packaging
DMT35M4LFVW-7	PowerDI3333-8 (SWP) (Type UX)	2,000/Tape & Reel
DMT35M4LFVW-13	PowerDI3333-8 (SWP) (Type UX)	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- $4. For packaging details, go to our website at \ https://www.diodes.com/design/support/packaging/diodes-packaging/.$

Marking Information



PowerDI is a registered trademark of Diodes Incorporated.



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	30	V		
Gate-Source Voltage			V_{GSS}	±20	V
Continuous Prais Current V 40V (Note 6)	Steady State	T _A = +25°C T _A = +70°C	lo	16 13	А
Continuous Drain Current, V _{GS} = 10V (Note 6)	Steady State	T _C = +25°C T _C = +70°C	lo	60 48	А
Maximum Body Diode Forward Current (Note 6)	Is	2.3	Α		
Pulsed Drain Current (380µs Pulse, Duty Cycle = 19	I _{DM}	110	Α		
Pulsed Drain Body Diode Forward Current (380µs F	I _{SM}	110	Α		
Avalanche Current (L = 0.1mH) (Note 8)	las	22	Α		
Avalanche Energy (L = 0.1mH) (Note 8)			Eas	25	mJ

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	1.5	W	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	83.3	°C/W	
Total Power Dissipation (Note 6)		PD	2.2	W	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	55	°C/W	
Thermal Resistance, Junction to Case (Note 7)		R ₀ JC	3.9	C/VV	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

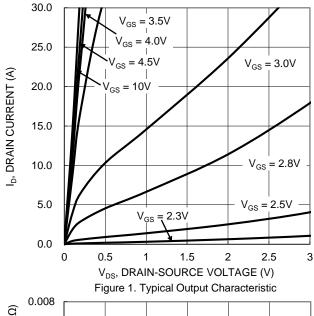
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)						•
Drain-Source Breakdown Voltage	BVDSS	30	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	1	μΑ	$V_{DS} = 24V$, $V_{GS} = 0V$
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)						•
Gate Threshold Voltage	Vgs(TH)	1.15	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance	D		4.6	6	mΩ	Vgs = 10V, ID = 20A
Static Drain-Source Off-Resistance	R _{DS(ON)}	_	6.5	9		$V_{GS} = 4.5V, I_D = 15A$
Diode Forward Voltage	VsD	_	0.7	1	V	V _G S = 0V, I _S = 1A
DYNAMIC CHARACTERISTICS (Note 10)						•
Input Capacitance	Ciss	_	982	_		V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz
Output Capacitance	Coss	_	903	_	pF	
Reverse Transfer Capacitance	Crss	_	27	_		
Gate Resistance	Rg	_	2.2	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	7.9	_		V _{DD} = 15V, I _D = 9A
Total Gate Charge (V _{GS} = 10V)	Qg	_	16.1	_	nC	
Gate-Source Charge	Q _{gs}	_	3.6	_	iiC	
Gate-Drain Charge	Qgd	_	1.2	_		
Turn-On Delay Time	t _D (ON)	_	8.1	_		V _{DD} = 15V, V _{GS} = 10V,
Turn-On Rise Time	t _R	_	2.2	_		
Turn-Off Delay Time	t _D (OFF)	_	16.8	_	ns	$R_g = 3\Omega$, $I_D = 9A$
Turn-Off Fall Time	tF	_	5.7	_		

5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided. Notes:

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
 9. Short duration pulse test used to minimize self-heating effect.
 10. Guaranteed by design. Not subject to product testing.





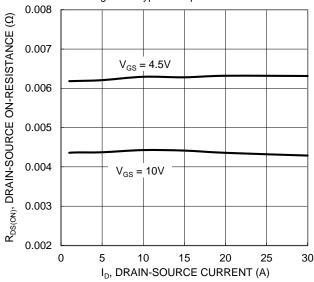


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

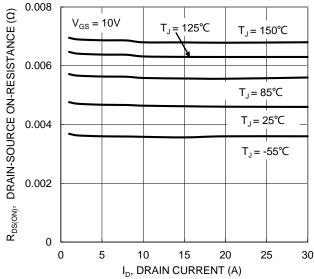
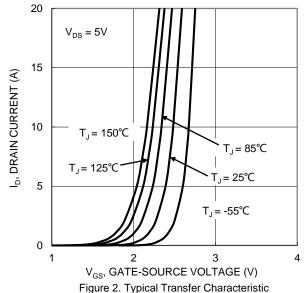


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature



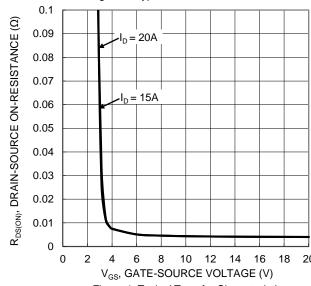


Figure 4. Typical Transfer Characteristic

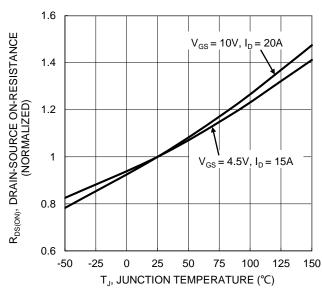


Figure 6. On-Resistance Variation with Junction Temperature





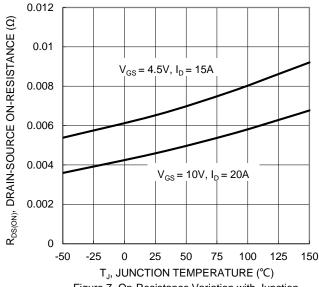
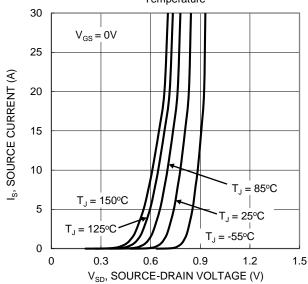
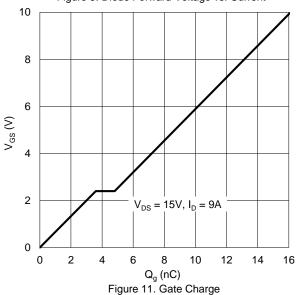


Figure 7. On-Resistance Variation with Junction Temperature



V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current



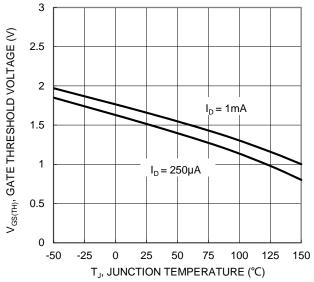
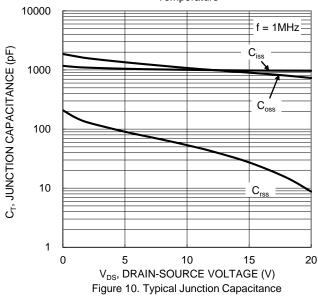
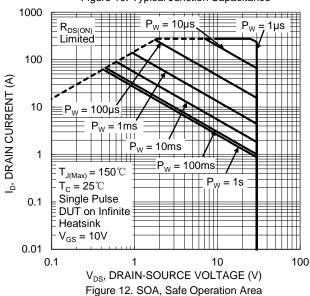


Figure 8. Gate Threshold Variation vs. Junction Temperature







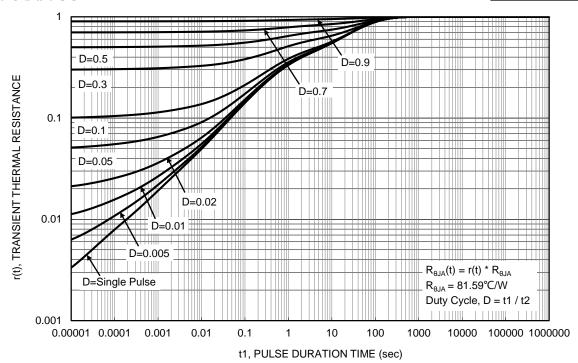


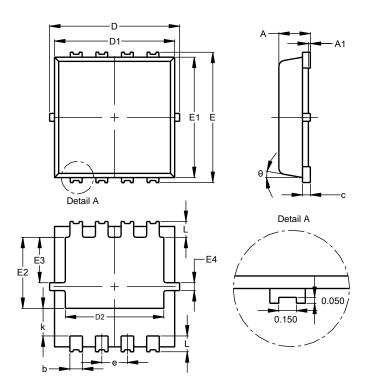
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (SWP) (Type UX)

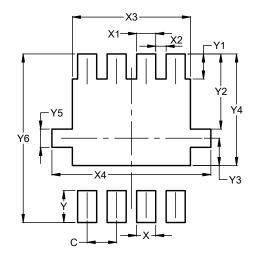


PowerDI3333-8 (SWP)							
	(Type UX)						
Dim	Min Max Typ						
Α	0.75	0.85	0.80				
A1	0.00	0.05					
b	0.25	0.40	0.32				
С	0.10	0.25	0.15				
D	3.20	3.40	3.30				
D1	2.95	3.15	3.05				
D2	2.30	2.70	2.50				
Е	3.20	3.40	3.30				
E1	2.95	3.15	3.05				
E2	1.60	2.00	1.80				
E3	0.95	1.35	1.15				
E4	0.10	0.30	0.20				
е	_	_	0.65				
k	0.50	0.90	0.70				
L	0.30	0.50	0.40				
θ	0°	12°	10°				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (SWP) (Type UX)



Dimensions	Value (in mm)			
С	0.650			
Х	0.420			
X1	0.420			
X2	0.230			
Х3	2.600			
X4	3.500			
Y	0.700			
Y1	0.550			
Y2	1.650			
Y3	0.600			
Y4	2.450			
Y5	0.400			
Y6	3.700			



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